

GA01PNS150-220

Silicon Carbide PiN Diode

 V_{RRM} 15.0 kV 1 A I_{F (Tc=25°C)}

Features

- 15 kV blocking
- 175 °C operating temperature
- Fast turn off characteristics
- Soft reverse recovery characteristics
- Ultra-Fast high temperature switching

Advantages

- Highest voltage rectifier commercially available
- Reduced stacking
- Reduced system complexity/Increased reliability

Package

• RoHS Compliant



Applications

- Voltage Multiplier
- Ignition/Trigger Circuits
- Oil/Downhole
- Lighting
- Defense

Maximum Ratings at T_j = 175 °C, unless otherwise specified

| Parameter | Symbol | Conditions | Values | Unit |
|-----------------------------------|-----------------|------------|------------|------|
| Repetitive peak reverse voltage | V_{RRM} | | 15 | kV |
| Continuous forward current | l _F | | 1 | Α |
| RMS forward current | $I_{F(RMS)}$ | | 0.5 | Α |
| Operating and storage temperature | T_j , T_stg | | -55 to 175 | °C |

Electrical Characteristics at T_j = 175 °C, unless otherwise specified

| Parameter | Symbol | Conditions | | Values | | Unit |
|-------------------------------|----------------|---|----------------|--------|------|------|
| | | Conditions | min. | typ. | max. | Unit |
| Diode forward voltage | V _F | I _F = 1 A, T _j = 25 °C | | 6.4 | | V |
| | | $I_F = 1 \text{ A}, T_j = 175 \text{ °C}$ | | 4.7 | | |
| Reverse current | I_{R} | $V_R = 8 \text{ kV}, T_j = 25 \text{ °C}$ | | 1 | 20 | ^ |
| | | $V_R = 8 \text{ kV}, T_j = 175 \text{ °C}$ | | | 100 | μΑ |
| Total reverse recovery charge | Q_{rr} | $I_F \subseteq I_{F,MAX}$ $I_L = 1$ | 1000 V .5 A | 558 | | nC |
| Switching time | t _s | $\begin{array}{c ccccccccccccccccccccccccccccccccccc$ | 1000 V .5 A | < 236 | | ns |
| | | $V_R = 1 \text{ V}, f = 1 \text{ MHz}, T_j = 2$ | 5 °C | 22 | | |
| Total capacitance | С | $V_R = 400 \text{ V}, f = 1 \text{ MHz}, T_j =$ | 25 °C | 4 | | pF |
| | | $V_R = 1000 \text{ V}, f = 1 \text{ MHz}, T_j =$ | 25 °C | 3 | | |
| Total capacitive charge | Q_{C} | $V_R = 1000 \text{ V}, f = 1 \text{ MHz}, T_j =$ | 25 °C | 4.5 | | nC |



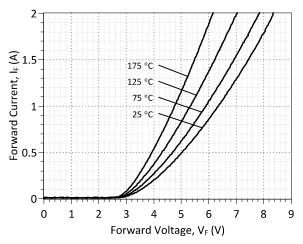


Figure 1: Typical Forward Characteristics

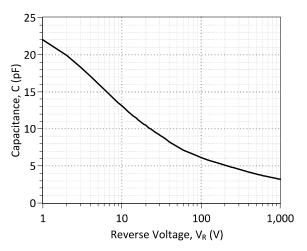


Figure 3: Typical Junction Capacitance vs Reverse Voltage Characteristics

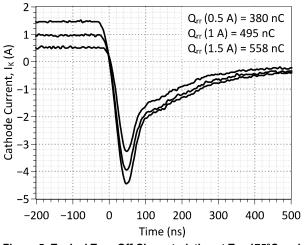


Figure 5: Typical Turn Off Characteristics at T_j = 175°C and V_R = 1000 V

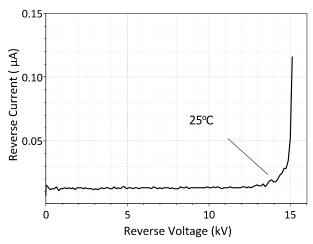


Figure 2: Typical Reverse Characteristics at 25°C

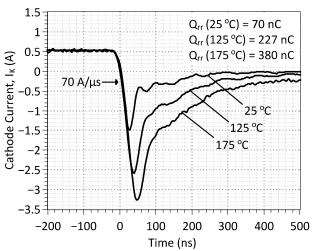


Figure 4: Typical Turn Off Characteristics at I_{k} = 0.5 A and V_{R} = 1000 V

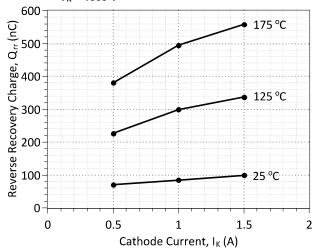


Figure 6: Reverse Recovery Charge vs Cathode Current



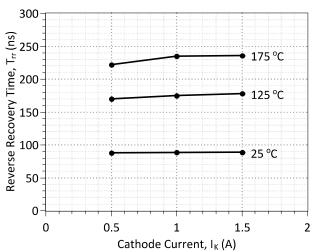
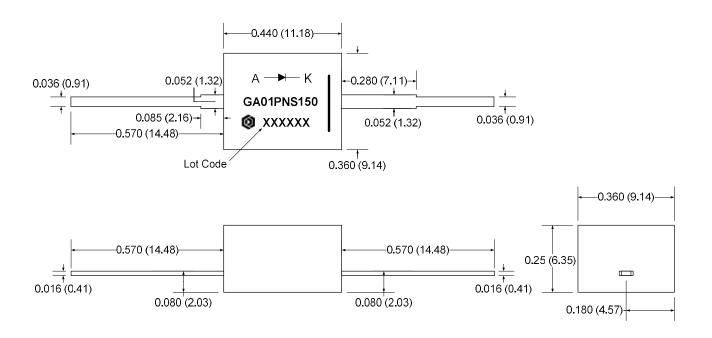


Figure 7: Reverse Recovery Time vs Cathode Current

Package Dimensions:

PACKAGE OUTLINE



- 1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
- 2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS



GA01PNS150-220

| Revision History | | | | | | |
|------------------|----------|------------------------------------|------------|--|--|--|
| Date | Revision | Comments | Supersedes | | | |
| 2015/04/30 | 1 | Updated Electrical Characteristics | | | | |
| 2014/11/07 | 0 | Initial release | | | | |

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SPICE Model Parameters

This is a secure document. Please copy this code from the SPICE model PDF file on our website (http://www.genesicsemi.com/sic_pin/GA01PNS150-220_SPICE.pdf) into LTSPICE (version 4) software for simulation of the GA01PNS150-220.

```
MODEL OF GeneSiC Semiconductor Inc.
     $Revision: 1.1
                                $
     $Date: 30-APR-2015
     GeneSiC Semiconductor Inc.
     43670 Trade Center Place Ste. 155
     Dulles, VA 20166
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* These models are provided "AS IS, WHERE IS, AND WITH NO WARRANTY
* OF ANY KIND EITHER EXPRESSED OR IMPLIED, INCLUDING BUT NOT LIMITED
* TO ANY IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A
* PARTICULAR PURPOSE."
* Models accurate up to 2 times rated drain current.
 Start of GA01PNS150-220 SPICE Model
.MODEL GA01PNS150 D
+ IS 9.2491e-015
         2.24770
+ RS
+ N
          3.3373
         0.00011784
+ IKF
          3.23
+ EG
+ XTI
         25
+ TRS1
         -0.0024
+ CJO
          2.28E-11
+ VJ
         2.304
+ M
         0.376
+ FC
         0.5
+ BV
         8000
         1.00E-03
+ IBV
         15000
+ VPK
+ IAVE
        SiC PiN
+ TYPE
+ MFG
         GeneSiC Semi
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* End of GA01PNS150-220 SPICE Model

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